

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2781576

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	KWANG SOO KIM	02/13/2013
	TAE HYUN KIM	02/12/2013
	BUM SEOK SUH	02/12/2013
	IN WHA JEONG	02/12/2013
	YOUNG KI LEE	02/12/2013
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Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.	
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City:	SUWON, GYUNGGI-DO	
State/Country:	KOREA, REPUBLIC OF	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	13789030
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NAME OF SUBMITTER:	J.R. HERRIN	
SIGNATURE:	/J.R. Herrin/	
DATE SIGNED:	03/24/2014	
Total Attachments: 1		
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U.S. ASSIGNMENT

5-611 700

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by
(Insert Name(s) & Address(es) of ASSIGNEE(S))

SAMSUNG ELECTRO-MECHANICS CO., LTD.
314 Maetan 3-dong, Yeongtong-gu, Suwon, Gyeonggi-do, Republic of Korea

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

POWER SEMICONDUCTOR MODULE

relating to International Patent Application PCT/_____/_____ and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____; (Insert date of execution of application, if not concurrent)

(b) filed on _____


Serial No. ____/____;

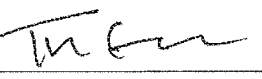
Any registered attorney of STAAS & HALSEY LLP, 1201 New York Ave., N.W., Suite 700, Washington, D.C. 20005 (202/434-1500) is hereby authorized to insert in (b) the specified data, when known.

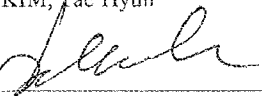
and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).
(Typed Name & Signature of Inventor(s)) (Date) (Typed Name & Signature of Witness(es))

1)  Feb. 13, 2013
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2)  Feb. 12, 2013
KIM, Tae Hyun

3)  Feb. 12, 2013
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5)  Feb. 12, 2013
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